

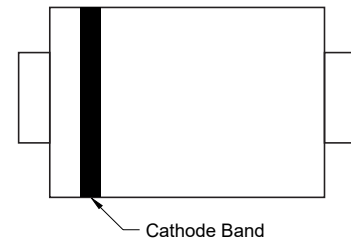
## SURFACE MOUNT SCHOTTKY BARRIER RECTIFIER

Reverse Voltage - 20 to 200 Volts Forward Current - 2.0 Ampere

### Features

- Metal silicon junction, majority carrier conduction
- For surface mounted applications
- Low power loss, high efficiency
- High forward surge current capability
- For use in low voltage, high frequency inverters, free wheeling, and polarity protection applications

DO-214AA/SMB **RoHS**  
COMPLIANT



### Equivalent circuit



### Mechanical Data

Case : DO-214AA/SMB molded plastic body

Terminals :Solderable per MIL-STD-750,Method2026

Polarity : Cathode line denotes the cathode end

Position: Any

Approx. Weight : 0.095g / 0.003oz

### Absolute Maximum Ratings and Electrical characteristics

Ratings at 25°C ambient temperature unless otherwise specified.Single phase, half wave, 60Hz resistive or inductive load,for capacitive load,derate by 20 %

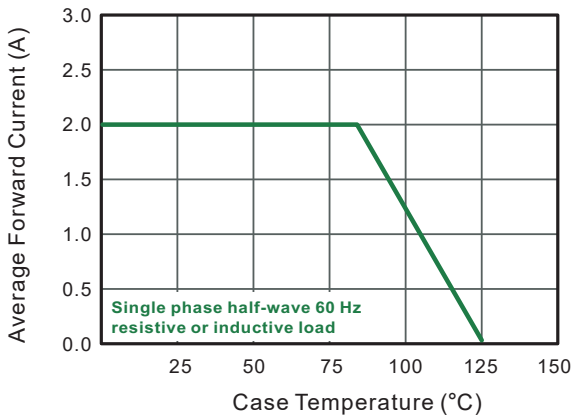
Parameter	SYMBOLS	SS22B	SS24B	SS26B	SS28B	SS210B	SS212B	SS215B	SS220B	UNITS	
		SS22	SS24	SS26	SS28	SS210	SS212	SS215	SS220		
Marking Code											
Maximum repetitive peak reverse voltage	$V_{RRM}$	20	40	60	80	100	120	150	200	V	
Maximum RMS voltage	$V_{RMS}$	14	28	42	56	70	84	105	140	V	
Maximum DC blocking voltage	$V_{DC}$	20	40	60	80	100	120	150	200	V	
Maximum average forward rectified current @Fig.1	$I_{F(AV)}$	2.0								A	
Peak forward surge current 8.3ms single half sine-wave superimposed onrated load (JEDEC Method)	$I_{FSM}$	55				45				A	
Maximum instantaneous forward voltage at 2.0A	$V_F$	0.55		0.70		0.85		0.95		V	
Maximum DCreverse current at rated DCblocking voltage $T_A=25^{\circ}C$ $T_A=125^{\circ}C$	$I_R$	0.5				0.3				mA	
		5.0				3.0					
Typical junction capacitance (NOTE 1)	$C_J$	220				110				pF	
Typical thermal resistance (NOTE 2)	$R_{\theta JA}$	60									°C/W
Operating junction temperature range	$T_J$	-55 to +125									°C
Storage temperature range	$T_{STG}$	-55 to +150									°C

**Note:**1.Measured at 1MHz and applied reverse voltage of 4.0V D.C.

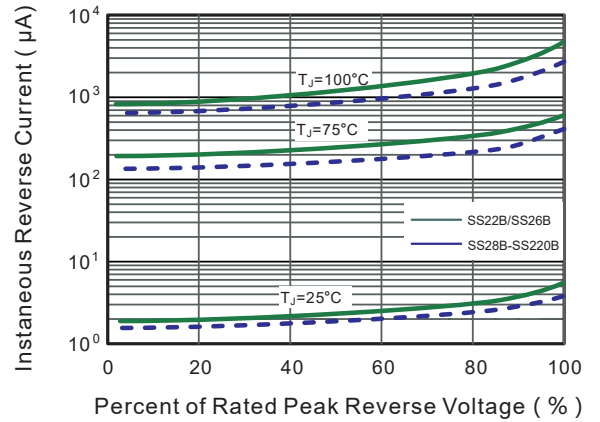
2.PC.B.mounted with 0.2"X0.2"(5 X5 mm) copper pad areas.

## Typical Characteristics

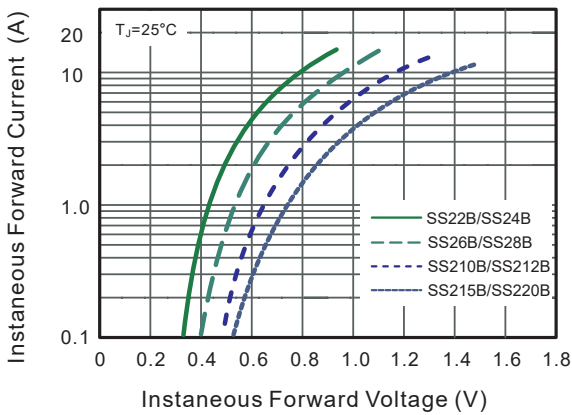
**Fig.1 Forward Current Derating Curve**



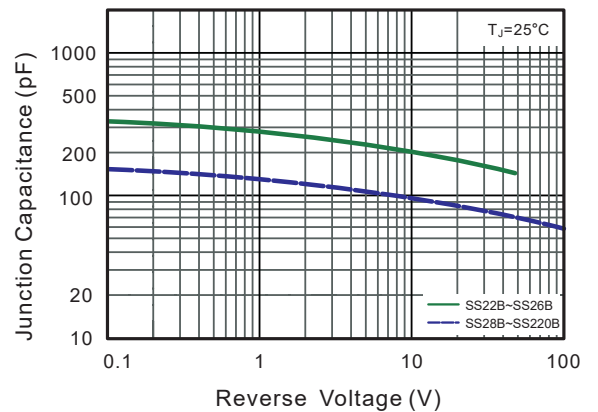
**Fig.2 Typical Reverse Characteristics**



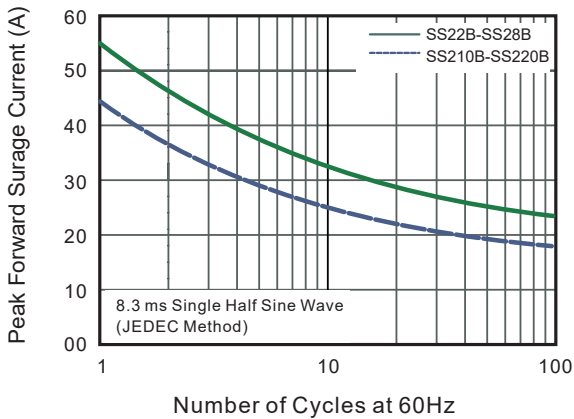
**Fig.3 Typical Forward Characteristic**



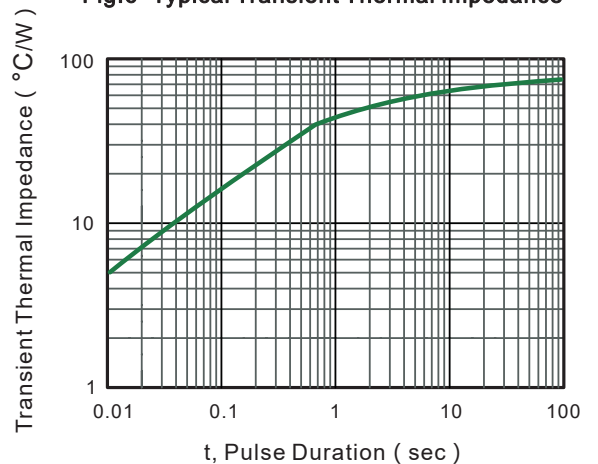
**Fig.4 Typical Junction Capacitance**



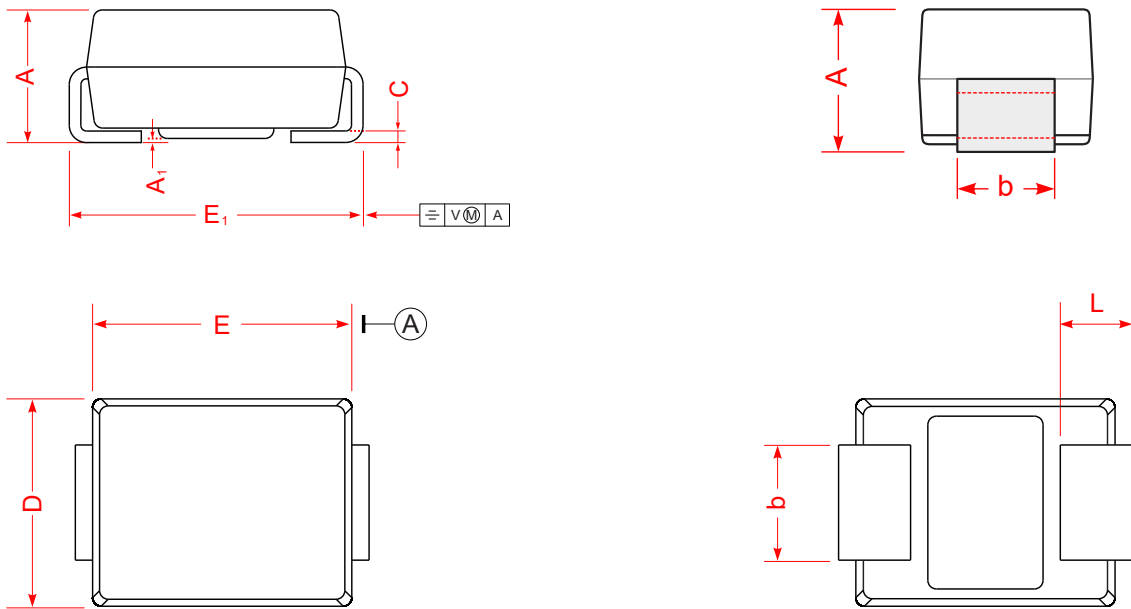
**Fig.5 Maximum Non-Repetitive Peak Forward Surge Current**



**Fig.6- Typical Transient Thermal Impedance**

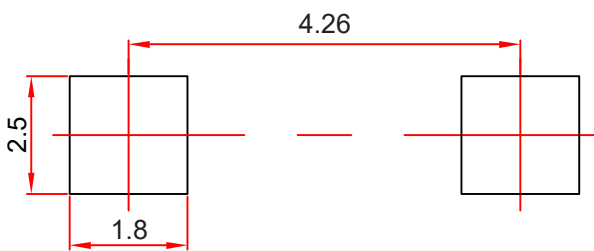


## DO-214AA/SMB Package Outline Dimensions



Symbol	imensions In Millimeters		imensions In Inches	
	Min	Max	Min	Max
A	2.13	2.44	0.084	0.096
C	0.15	0.31	0.006	0.012
D	3.30	3.95	0.130	0.156
E	4.06	4.70	0.160	0.185
E <sub>1</sub>	5.08	5.59	0.200	0.220
b	1.90	2.20	0.075	0.087
L	0.80	1.50	0.031	0.059
A <sub>1</sub>	0.2 REF		0.008 REF	

## DO-214AA/SMB Suggested Pad Layout



- Note:
1. Controlling dimension: in/millimeters.
  2. General tolerance:  $\pm 0.05\text{mm}$ .
  3. The pad layout is for reference purposes only.